NASA/TM-20220005556



Semicoa JANS2N2907AUB Total Ionizing Dose Test Report

Edward P. Wilcox

NASA STI Program Report Series

The NASA STI Program collects, organizes, provides for archiving, and disseminates NASA's STI. The NASA STI program provides access to the NTRS Registered and its public interface, the NASA Technical Reports Server, thus providing one of the largest collections of aeronautical and space science STI in the world. Results are published in both non-NASA channels and by NASA in the NASA STI Report Series, which includes the following report types:

- TECHNICAL PUBLICATION. Reports of completed research or a major significant phase of research that present the results of NASA Programs and include extensive data or theoretical analysis. Includes compilations of significant scientific and technical data and information deemed to be of continuing reference value. NASA counterpart of peer-reviewed formal professional papers but has less stringent limitations on manuscript length and extent of graphic presentations.
- TECHNICAL MEMORANDUM.
 Scientific and technical findings that are preliminary or of specialized interest, e.g., quick release reports, working papers, and bibliographies that contain minimal annotation. Does not contain extensive analysis.
- CONTRACTOR REPORT. Scientific and technical findings by NASA-sponsored contractors and grantees.

- CONFERENCE PUBLICATION.
 Collected papers from scientific and technical conferences, symposia, seminars, or other meetings sponsored or co-sponsored by NASA.
- SPECIAL PUBLICATION. Scientific, technical, or historical information from NASA programs, projects, and missions, often concerned with subjects having substantial public interest.
- TECHNICAL TRANSLATION.
 English-language translations of foreign scientific and technical material pertinent to NASA's mission.

Specialized services also include organizing and publishing research results, distributing specialized research announcements and feeds, providing information desk and personal search support, and enabling data exchange services.

For more information about the NASA STI program, see the following:

- Access the NASA STI program home page at http://www.sti.nasa.gov
- Help desk contact information:

https://www.sti.nasa.gov/sti-contact-form/ and select the "General" help request type.

NASA/TM-20220005556



Semicoa JANS2N2907AUB Total Ionizing Dose Test

Edward P. Wilcox Goddard Space Flight Center, Greenbelt, MD

Test Date: 8/20/2021 Report Date: 4/4/2022

National Aeronautics and Space Administration

Goddard Space Flight Center Greenbelt, MD 20771

Acknowledgments

This work was sp	onsored by the	e NASA GSF	C Radiation	Effects a	and Analys	is Group
and supported by	the Roman S	pace Telesco	pe mission.			

Trade names and trademarks are used in this report for identification only. Their usage does not constitute an official endorsement, either expressed or implied, by the National Aeronautics and Space Administration.

Level of Review: This material has been technically reviewed by technical management.

Available from

NASA STI Program Mail Stop 148 NASA's Langley Research Center Hampton, VA 23681-2199 National Technical Information Service 5285 Port Royal Road Springfield, VA 22161 703-605-6000

This report is available in electronic form at https://radhome.gsfc.nasa.gov/

Table of Contents

e of Contents	2
DEVICES TESTED	3
le 1. Part Identification Information	3
TEST SETUP	4
TEST DESCRIPTION	4
RESULTS	6
SUMMARY	6
References	6
	le of Contents

1. Introduction

This test serves as the radiation lot acceptance test (RLAT) for the Semicoa JANS2N2907AUB date codes specified. During testing, the device was exposed to low dose rate (LDR) gamma irradiation at a dose rate of 10 mrad(Si)/s. Datasheet parameters were characterized over dose, with an emphasis on gain degradation, and data are presented at 0 krad and 30 krad within.

2. DEVICES TESTED

2.1. Part Background

The JANS2N2907AUB is a space-grade PNP transistor qualified to MIL-PRF-19500/291W and sold with no radiation hardness assurance level, though the manufacturer offers higher levels of RHA as an option. AUB suffix indicates a 3-pin surface mount package.

2.2. Device Under Test (DUT) Information

Package

A total of 88 parts over 4 batches were provided for testing in groups of 22. All specifications and descriptions are according to MIL-PRF-19500/291W. More information can be found in Table 1.

JANS2N2907AUB **Part Number SEMICOA** Manufacturer 2026, 2012A, 2028, 1921 Lot Date Code 21-005, 006, 007, 008 **REAG ID** 80 + 8 controls **Quantity Tested** PNP small signal transistor **Part Function** Bipolar junction transistor Part Technology 3-pin surface mount (AUB)

Table 1. Part Identification Information

3. TEST SETUP

General test procedures were in accordance with MIL-STD-883, Method 1019, Condition D. Parts were serialized randomly. ESD procedures were followed during test and transfer of the devices between irradiation chamber and characterization. Exposures were performed at ambient laboratory temperature.

Measurements were performed with Keithley 2400 source-measurement units and Keithley 4200 semiconductor characterization system in the GSFC Code 561 laboratories. Data was collected with LabVIEW and tabulated in Microsoft Excel.

4. TEST DESCRIPTION

4.1 Irradiation Conditions

Radiation testing was performed with gamma radiation at 10 mrad(Si)/s. Eighty (80) parts were irradiated with 8 reserved as controls, divided among four lot date codes. Half the irradiated parts from each group were exposed in a biased configuration and half were grounded. Prior to the first radiation dose, all 88 parts were electrically tested. After each exposure level, the parts were tested again and returned to radiation within the time limits defined by MIL-STD-883, Method 1019. See Table 2 for more information.

Parts indicated as "biased" were irradiated with $V_{CE} = -35$ V. Parts indicated unbiased had all terminals shorted together and tied to an external ground potential.

Group	LDC	Qty	Bias	Dose Rate	Exposure Level Steps (krad(Si))
1	2026	10	Unbiased	10 mrad/s	0, 30
2	2026	10	Biased	10 mrad/s	0, 30
3	2026	2	Control		
4	2012A	10	Unbiased	10 mrad/s	0, 30
5	2012A	10	Biased	10 mrad/s	0, 30
6	2012A	2	Control		
7	2028	10	Unbiased	10 mrad/s	0, 30
8	2028	10	Biased	10 mrad/s	0, 30
9	2028	2	Control		
10	1921	10	Unbiased	10 mrad/s	0, 30
11	1921	10	Biased	10 mrad/s	0, 30
12	1921	2	Control		

Table 2. Device Grouping

4.2 Electrical Tests

Specification thresholds were set in accordance with MIL-PRF-19500/291W. Where noted by (RHA), specifications are the post-radiation limits provided in MIL-PRF-19500/291W. For the application intended, the selection of these JANS parts with in-house RLAT was an alternative to procurement of JANSR parts. Therefore, parts were tested against the relaxed post-radiation limits of the JANSR parts and not to the pre-irradiation limits provided for the JANS device procured.

All data from the electrical tests in Table 3 were logged in excel spreadsheet files.

Table 3. List of Electrical Tests Performed

Symbol	Parameter	MIN	TYP	MAX	Units	Test Conditions
V _{(BR)CEO}	Emitter-Collector Breakdown Voltage	60			V	I _C = 10mA
I _{CBO,1}	Collector-Base Cutoff Current			10	uA	V _{CB} = 60 V
I _{СВО,2}	Collector-Base Cutoff Current			10	nA	V _{CB} = 50 V
I _{CES}	Collector-Emitter Cutoff Current			50	nA	V _{CE} = 50 V
I _{EBO,1}	Emitter-Base Cutoff Current			10	uA	V _{EB} = 5 V
I _{EBO,2}	Emitter-Base Cutoff Current			50	nA	V _{EB} = 4 V
h _{FE1}	DC Current Gain (RHA)	37.5				$I_C = 0.1 \text{ mA, } V_{CE} = 10 \text{ V}$
h _{FE2}	DC Current Gain (RHA)	50		450		$I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}$
h _{FE3}	DC Current Gain (RHA)	50				I _C = 10 mA, V _{CE} = 10 V
h _{FE4}	DC Current Gain (RHA)	50		300		I _C = 150 mA, V _{CE} = 10 V
V _{BE} (SAT),1	Base-Emitter Saturation Voltage	-0.6		-1.3	V	I _C = 150 mA, I _B = 15 mA
V _{BE(SAT),2}	Base-Emitter Saturation Voltage			-2.6	V	I _C = 500 mA, I _B = 50 mA
V _{CE(SAT),1}	Collector-Emitter Saturation Voltage			-0.4	V	I _C = 150 mA, I _B = 15 mA
VCE(SAT),2	Collector-Emitter Saturation Voltage			-1.6	V	I _C = 500 mA, I _B = 50 mA

6. SOURCE REQUIREMENTS

The total dose source is in a room air source gamma ray facility, which is compliant with MIL-STD-883, Method 1019. Dosimetry is NIST traceable.

7. RESULTS

	Average o		99/90 statistical range after 30		Comments	
	irradiated	lots	krad(Si)			
Parameter	0 krad	30 krad	Low Bound	High Bound		
	(Si)	(Si)				
V _{(BR)CEO}	> 60 V	> 60 V	n/a	n/a	All parts within spec	
I _{CBO,1}	-0.201 nA	-0.664 nA	-1.75 nA	+0.425 nA	All parts within spec	
I _{CBO,2}	-0.609 nA	-1.05 nA	-2.74 nA	+0.634 nA	All parts within spec	
ICES	-0.239 nA	-0.825 nA	-1.21 nA	-0.438 nA	All parts within spec	
I _{EBO,1}	0.553 nA	0.960 nA	0.204 nA	1.72 nA	All parts within spec	
I _{EBO,2}	0.331 nA	0.529 nA	0.018 nA	1.04 nA	All parts within spec	
h _{FE1}	196	64	46.2	80.9	All parts within spec	
h _{FE2}	212	98	84.4	112.0	All parts within spec	
h _{FE3}	220	121	93.4	148.2	All parts within spec	
h _{FE4}	258	159	80.2	237.6	All parts within spec	
V _{BE(SAT),1}	-0.868 V	-0.860 V	-0.959 V	-0.760 V	All parts within spec	
V _{BE(SAT),2}	-1.008 V	-0.988 V	-1.08 V	-0.897 V	All parts within spec	
V _{CE} (SAT),1	-0.224 V	-0.246 V	-0.332 V	-0.159 V	All parts within spec	
V _{CE(SAT),2}	-0.685 V	-0.799 V	-1.01 V	-0.587 V	All parts within spec	

8. SUMMARY

All parameters met specification limits for the JANS2N2907AUB after 30 krad(Si) of low-dose rate gamma irradiation, with the exception of the DC current gain values which are tested against the post-radiation limits provided for JANSR2N2907AUB. Statistical bounds are presented to guide appropriate usage of the parts in the 30-krad application.

9. REFERENCES

- Department of Defense "Test Method Standard Microcircuits," MIL-STD-883 Test Method 1019.9 Ionizing radiation (total dose) test procedure, June 7, 2013, https://landandmaritimeapps.dla.mil/Downloads/MilSpec/Docs/MIL-STD-883/std883.pdf.
- 2) MIL-PRF-19500/291W, effective 17 May 2016.

